

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	8225	semiconductor near module\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 13:45
L2	90473	semiconductor and module\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 13:45
L3	17	1 and (((power near switch\$3) MIS) with (IC (intergrated near circuit)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 13:51
L4	171	2 and (((power near switch\$3) MIS) with (IC (intergrated near circuit)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 13:50
L5	308	2 and (((power near switch\$3) MIS) with (IC (integrated near circuit)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 14:53
L6	20	1 and (((power near switch\$3) MIS) with (IC (integrated near circuit)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 16:17
L7	2	5 and (flip near chip near bond\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 16:16
L8	28	("2577584" "3716764" "4045867" "4067951" "4126292" "4569814" "4689103" "4900501" "4946633" "4979289" "5052907" "5071612" "5175007" "5239198" "5468999" "5474958" "5542171" "5556647" "5578261" "5624691" "5674785" "5682673" "5741530" "5744083" "5744084" "5804467").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/02 13:54

L9	26	("4199777" "4483067" "4505799" "4899107" "4954458" "4992849" "4992850" "5022580" "5041396" "5063177" "5068205" "5075253" "5138434" "5155067" "5188984" "5200363" "5239198" "5326428" "5346859" "5346861" "5419807" "5426072" "5468999" "5474957" "5536685" "5545291").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/02 14:12
L10	2590	(power near (MOS MIS switch\$3)) with (IC (integrated near circuit))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 14:54
L11	239	10 and ((thermal heat) near (dissipat\$3 sink))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 14:56
L12	98	11 and substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 14:56
L13	7286	(flip near chip near bond\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 16:16
L14	0	13 and ((power near (MOS MIS)) with (IC (integrated near circuit)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 16:20
L15	0	13 and ((power near (MOS MIS)) near (die chip))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 16:19
L16	6	13 and ((power near (MOSFET MIS)) near (die chip))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 16:19

L17	43	13 and ((power near (die chip)) with (IC (integrated near circuit)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 16:33
L18	186	13 and (power near (die\$1 chip\$1))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 16:33
S1	16855	257/778,81,99,177-181,584,625,675,688, 689,705-707,712-722,796.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 08:50
S2	2	S1 and ((power near switch\$3) with (driv\$3 near (IC (intergrated near circuit))))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 13:46
S3	4	("5109318" "5373418" "5375040" "5514917").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/01 18:46
S4	849	S1 and (flip near chip near bond\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 13:52
S5	80	S4 and (power near (device\$1 chip\$1 IC circuit\$1))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:00
S6	234	S4 and (heat near sink)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 14:54
S7	22	S6 and (resin with seal\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:09

S8	734119	"257"/\$.ccls. "438"/\$.ccls. "361"/\$.ccls. "29"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:03
S9	14	S8 and ((power near switch\$3) with (driv\$3 near (IC (intergrated near circuit))))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:06
S10	1176	S8 and (DC near DC near converter\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:14
S11	10	S10 and (flip near chip near bond\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:15
S12	205	S10 and (heat near sink)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:16
S13	14	S12 and (resin with seal\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:16
S14	24000	(DC near DC near converter\$1)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:14
S15	17	S14 and (flip near chip near bond\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:15
S16	674	S14 and (heat near sink)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:16

S17	15	S16 and (resin with seal\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:16
S18	16	("3303265" "3996603" "4788626" "5168344" "5248901" "5297001" "5446314" "5532513" "5689089" "5750926" "5942796" "5945735" "6078501" "6297549" "6303974").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/01 19:18
S19	8	("4788626" "5168344" "5248901" "5446314" "5750926" "5942796" "5945735" "6078501").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/01 19:20
S20	7	("5315482" "5557502" "5631807" "5701231" "5710733" "5712762" "5847935").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/01 19:28
S21	14	S14 and ((power near switch\$3) with (driv\$3 near (IC (intergrated near circuit))))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:30
S22	16	S14 and ((power near switch\$3) with (driv\$3 near (IC (integrated near circuit))))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/01 19:30
S23	7	("5726869" "5734563" "5870299" "5920473" "6400579" "6466458" "6466462").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/06/01 19:31
S24	4	(("6040626") or ("6396127")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2005/06/02 08:53
S25	1	10/643717	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 08:54
S26	2	10/438106	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 08:58

S27	0	11/022765	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 08:59
S28	2	"11022765"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 09:11
S29	93	high near speed near imag\$3 near sens\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 09:31
S30	3819	cmos near imag\$3 near sens\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 09:32
S31	22	S30 and (photo near electric near conversion)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/06/02 13:45